TOSHIBA Power Transistor Module Silicon NPN Epitaxial Type
(Four Darlington Power Transistors in One)

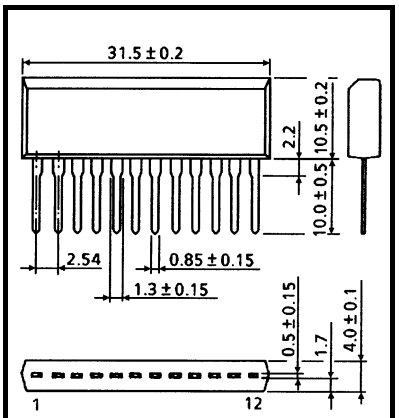
MP4303

Industrial Applications

High Power Switching Applications

Hammer Drive, Pulse Motor Drive and Inductive Load Switching

Unit: mm



TRANSISTOR PART
1, 5, 8, 12 BASE
2, 4, 9, 11 COLLECTOR
6, 7 EMITTER
DIODE PART
2, 4, 9, 11 ANODE
3, 10 CATHODE

JEDEC	—
JEITA	—
TOSHIBA	2-32C1B

Weight: 3.9 g (typ.)

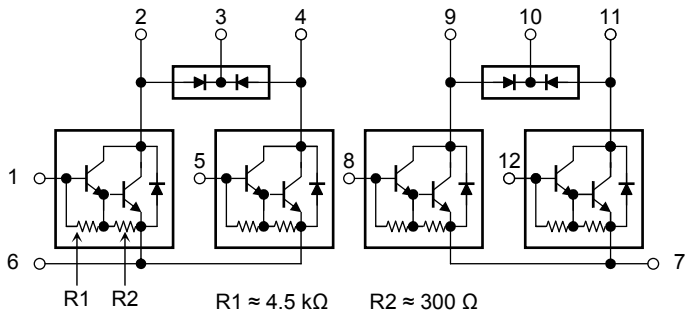
- Small package by full molding (SIP 12 pins)
- High collector power dissipation (4-device operation)
  : P_T = 4.4 W (Ta = 25°C)
- High collector current: $I_{C\ (DC)}$ = 2 A (max)
- High DC current gain: h_{FE} = 2000 (min) (V_{CE} = 2 V, I_C = 1 A)

Absolute Maximum Ratings (Ta = 25°C)

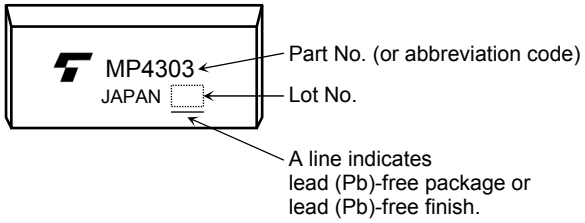
Characteristics		Symbol	Rating	Unit
Collector-base voltage		V_{CBO}	120	V
Collector-emitter voltage		V_{CEO}	100	V
Emitter-base voltage		V_{EBO}	6	V
Collector current	DC	I_C	2	A
	Pulse	I_{CP}	4	
Continuous base current		I_B	0.5	A
Collector power dissipation (1 -evice operation)		P_C	2.2	W
Collector power dissipation (4-device operation)		P_T	4.4	W
Junction temperature		T_j	150	°C
Storage temperature range		T_{stg}	−55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Array Configuration



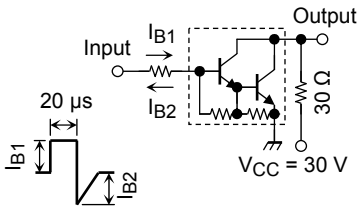
Marking



Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance from junction to ambient (4-device operation, Ta = 25°C)	$\Sigma R_{th\ (j\text{-}a)}$	28.4	°C/W
Maximum lead temperature for soldering purposes (3.2 mm from case for 10 s)	T_L	260	°C

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current		I_{CBO}	V_{CB} = 120 V, I_E = 0 A	—	—	10	μA
Collector cut-off current		I_{CEO}	V_{CE} = 100 V, I_B = 0 A	—	—	10	μA
Emitter cut-off current		I_{EBO}	V_{EB} = 6 V, I_C = 0 A	0.5	—	2.5	mA
Collector-base breakdown voltage		$V_{(BR)\ CBO}$	I_C = 1 mA, I_E = 0 A	120	—	—	V
Collector-emitter breakdown voltage		$V_{(BR)\ CEO}$	I_C = 10 mA, I_B = 0 A	100	—	—	V
DC current gain		$h_{FE\ (1)}$	V_{CE} = 2 V, I_C = 1 A	2000	—	15000	—
		$h_{FE\ (2)}$	V_{CE} = 2 V, I_C = 2 A	1000	—	—	
Saturation voltage	Collector-emitter	$V_{CE\ (sat)}$	I_C = 1 A, I_B = 1 mA	—	—	1.5	V
	Base-emitter	$V_{BE\ (sat)}$	I_C = 1 A, I_B = 1 mA	—	—	2.0	
Transition frequency		f_T	V_{CE} = 2 V, I_C = 0.5 A	—	100	—	MHz
Collector output capacitance		C_{ob}	V_{CB} = 10 V, I_E = 0 A, f = 1 MHz	—	20	—	pF
Switching time	Turn-on time	t_{on}		—	0.4	—	μs
	Storage time	t_{stg}		—	4.0	—	
	Fall time	t_f		—	0.6	—	

$I_{B1} = -I_{B2}$ = 1 mA, duty cycle ≤ 1%

Emitter-Collector Diode Ratings and Characteristics (Ta = 25°C)

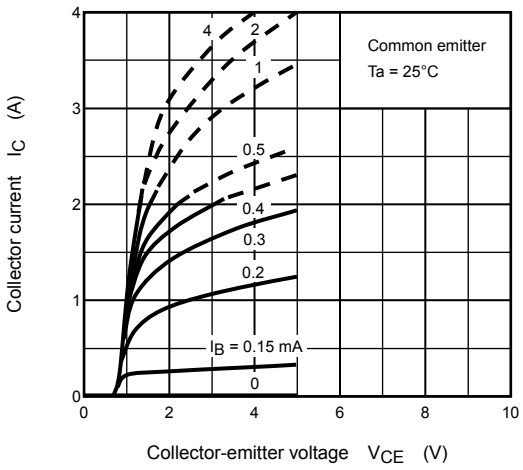
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Maximum forward current	I_{FM}	—	—	—	2	A
Surge current	I_{FSM}	t = 1 s, 1 shot	—	—	4	A
Forward voltage	V_F	I_F = 0.5 A, I_B = 0 A	—	—	2.0	V
Reverse recovery time	t_{rr}	I_F = 2 A, V_{BE} = −3 V, dI_F/dt = −50 A/μs	—	1.0	—	μs
Reverse recovery charge	Q_{rr}		—	5	—	μC

Flyback-Diode Rating and Characteristics (Ta = 25°C)

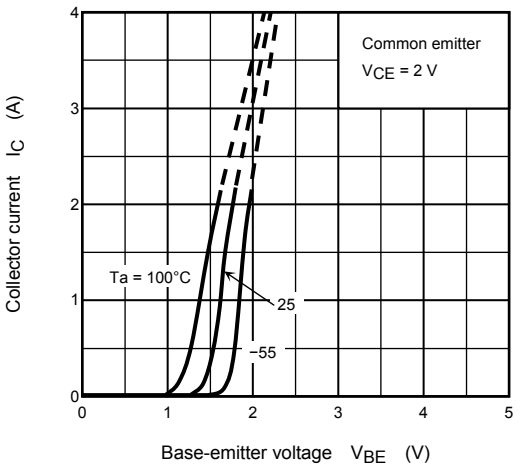
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Maximum forward current	I_{FM}	—	—	—	2	A
Reverse current	I_R	V_R = 120 V	—	—	0.4	μA
Reverse voltage	V_R	I_R = 100 μA	120	—	—	V
Forward voltage	V_F	I_F = 0.5 A	—	—	1.8	V

查询"MP4303_07"供应商

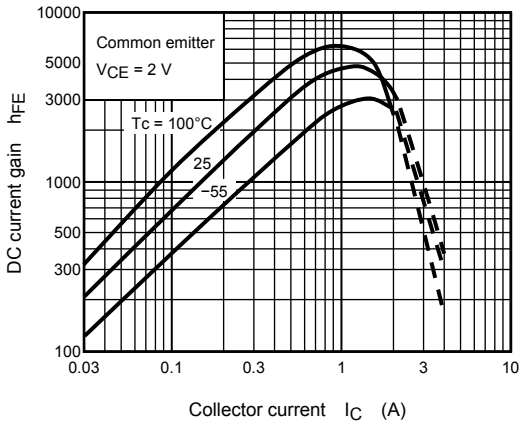
$I_C - V_{CE}$



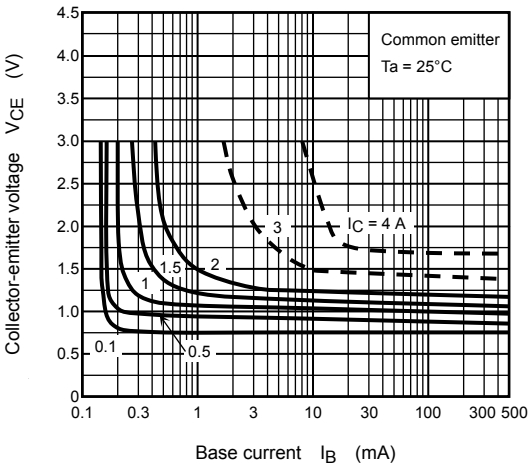
$I_C - V_{BE}$



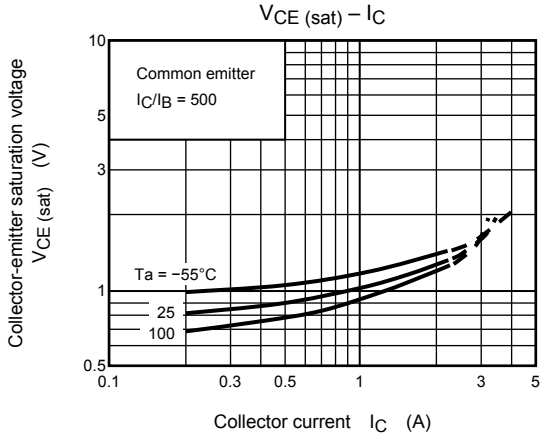
$h_{FE} - I_C$



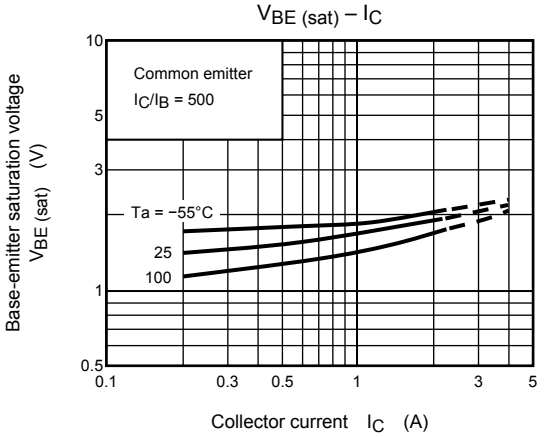
$V_{CE} - I_B$



$V_{CE\ (sat)} - I_C$

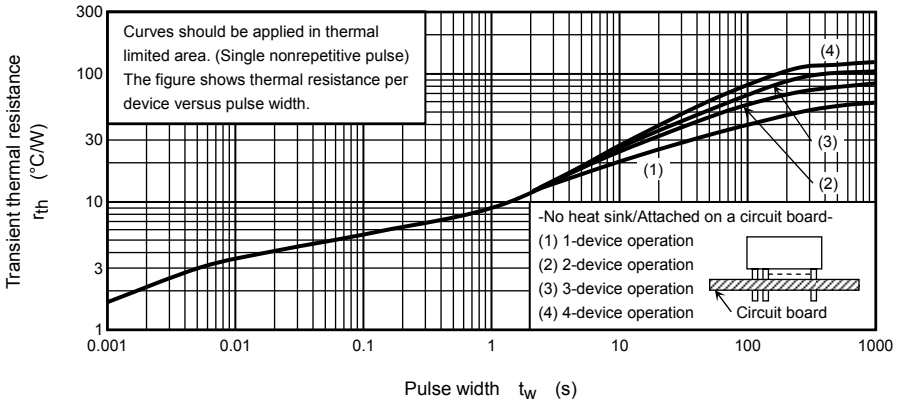


$V_{BE\ (sat)} - I_C$

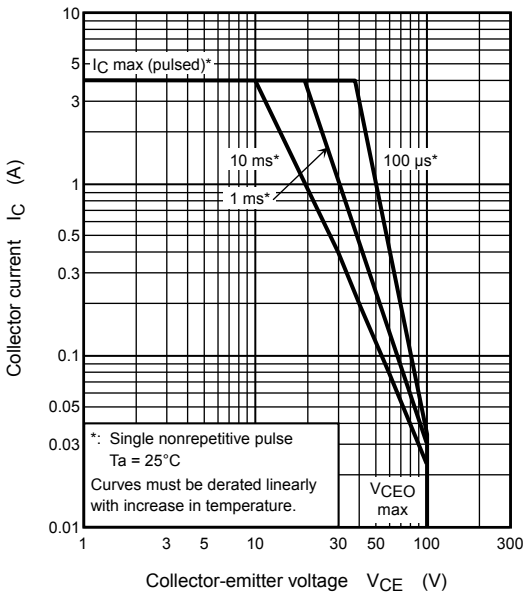


查询"MP4303_07"供应商

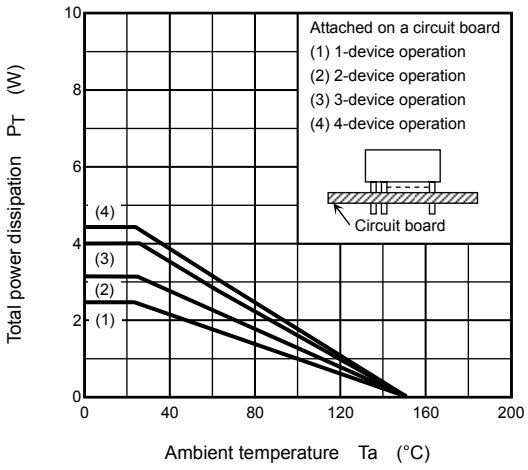
$r_{th} - t_w$



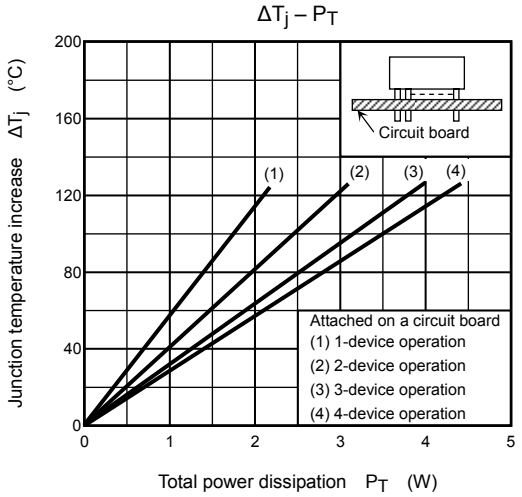
Safe Operating Area



P_T – Ta



$\Delta T_j - P_T$



RESTRICTIONS ON PRODUCT USE

20070701-EN

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the “Handling Guide for Semiconductor Devices,” or “TOSHIBA Semiconductor Reliability Handbook” etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.).These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury (“Unintended Usage”). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer’s own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patents or other rights of TOSHIBA or the third parties.
- Please contact your sales representative for product-by-product details in this document regarding RoHS compatibility. Please use these products in this document in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses occurring as a result of noncompliance with applicable laws and regulations.